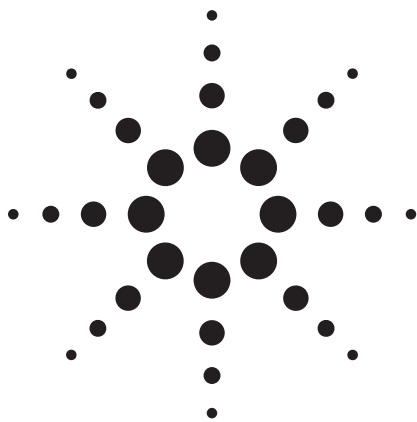




Agilent HSMx-A16x-xxxxx PLCC-2 Surface Mount LED Indicator Black Surface Tinted Data Sheet

Description

This family of SMT LEDs is packaged in the industry standard PLCC-2 package. These SMT LEDs have high reliability performance and are designed to work under a wide range of environmental conditions. This high reliability feature makes them ideally suited to be used under harsh interior signs application conditions. This SMT LED package come with a black surface and tinted which is specially designed for signs application to minimize ambient reflection to improve contrast.

To facilitate easy pick & place assembly, the LEDs are packed in EIA-compliant tape and reel. Every reel will be shipped in single intensity and color bin, except red color, to provide close uniformity.

These LEDs are compatible with IR solder reflow process. Due to the high reliability feature of these products, they can also be mounted using through-the-wave soldering process.

The super wide viewing angle at 120° makes these LEDs ideally suited for panel, push button, or general backlighting in automotive interior, office equipment, industrial equipment, and home appliances. The flat top emitting surface makes it easy for these LEDs to mate with light pipes. With the built-in reflector pushing up the intensity of the light output, these LEDs are also suitable to be used as LED pixels in interior electronic signs.

Features

- Industry standard PLCC-2 package
- High reliability LED package
- High brightness using AlInGaP and InGaN dice technologies
- Available in full selection of colors
- Super wide viewing angle at 120°
- Available in 8 mm carrier tape on 7 inch reel (2000 pieces)
- Compatible with both IR and TTW soldering process
- Black Surface Tinted

Applications

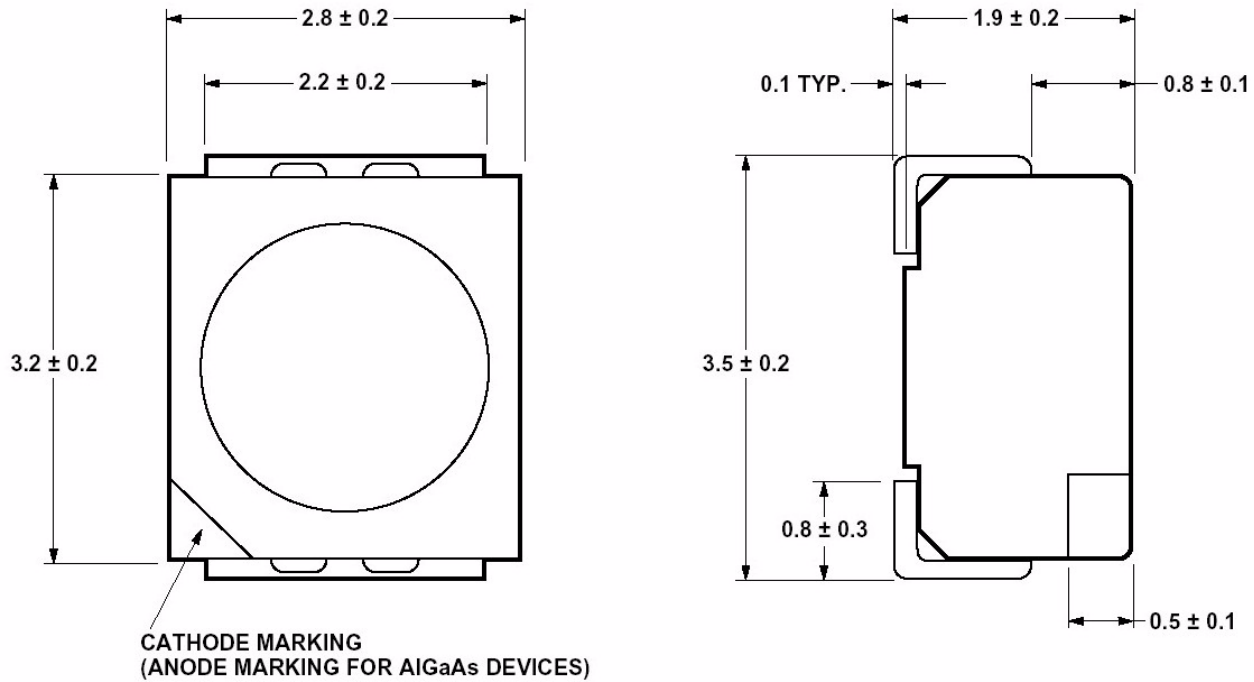
- Electronic signs and signals
 - Interior full color sign
 - Variable message sign

CAUTION: HSM and HSMN-A1xx-xxxxx LEDs are Class 2 ESD sensitive. Please observe appropriate precautions during handling and processing. Refer to Agilent Application Note AN-1142 for additional details.



Agilent Technologies

Package Dimensions



Notes: All dimensions in mm

Device Selection Guide

Color	Part Number	Min I_v @ 20mA (mcd)	Typical I_v @ 20mA (mcd)
Red	HSMC-A160-Q00J1	63.0	100.0
	HSMC-A161-S00J1	160.0	220.0
	HSMZ-A160-T00J1	250.0	350.0
Yellow / Amber	HSMA-A160-Q00J1	63.0	100.0
	HSMA-A161-S00J1	160.0	220.0
	HSMU-A160-R00J1	100.0	320.0
	HSMU-A160-T00J1	250.0	320.0
Green	HSMM-A161-R00J1	100.0	200.0
	HSMM-A160-S00J1	160.0	350.0
Blue	HSMN-A161-N00J1	25.0	50.0
	HSMN-A160-P00J1	40.0	70.0

Notes: The luminous intensity I_v is measured at the mechanical axis of the lamp package.
The actual peak of the spatial radiation pattern may not be aligned with this axis.

Absolute Maximum Ratings (T_A = 25°C)

Parameters	HSMC/A	HSMV/Z	HSMM/N
DC Forward Current ^[1]	30 mA ^[3,4]	30 mA ^[3,4]	30 mA
Peak Forward Current ^[2]	100mA	100mA	100mA
Power Dissipation	63mW	72mW	114mW
Reverse Voltage	5	5	5
Junction Temperature	110°C	110°C	110°C
Operating Temperature	-55°C to +100°C	-55°C to +100°C	-55°C to +100°C
Storage Temperature	-55°C to +100°C	-55°C to +100°C	-55°C to +100°C

Notes:

1. Derate linearly as shown in figure
2. Duty factor = 10%, Frequency = 1kHz.
3. Drive Current between 10mA and 30mA are recommended for best long term performance
4. Operation at current below 5mA is not recommended.

Optical Characteristic (T_A = 25°C)

Color	Part Number	Dice Technology	Peak Wavelength λ_{PEAK} (nm) Typ.	Dominant Wavelength λ_{D} (nm) ^[1] Typ.	Viewing Angle $2\theta_{1/2}$ ^[2] (Degrees) Typ.	Luminous Efficacy η_v ^[3] (lm/W) Typ	Luminous Intensity/ Total Flux I_v (mcd)/ F_v (mlm) Typ.
Amber	HSMA-A16x	AlInGaP	592	590	120	480	0.45
Amber	HSMU-A160	AlInGaP	594	592	120	500	0.45
Red	HSMC-A16x	AlInGaP	635	626	120	150	0.45
Red	HSMZ-A160	AlInGaP	639	630	120	155	0.45
Green	HSMM-A16x	InGaN	523	525	120	500	0.45
Blue	HSMN-A16x	InGaN	468	470	120	75	0.45

Notes:

1. The dominant wavelength, λ_D , is derived from the CIE Chromaticity Diagram and represents the color of the device.
2. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is 1/2 the peak intensity.
3. Radiant intensity, I_e in watts/steradian, may be calculated from the equation $I_e = I_v/\eta_v$, where I_v is the luminous intensity in candelas and η_v is the luminous efficacy in lumens/watt.

Electrical Characteristic (T_A = 25°C)

Dice Technology	Forward Voltage V_F (Volts) @ $I_F = 20\text{mA}$		Reverse Voltage V_R @ 100 μA	Reverse Voltage V_R @ 10 μA	Thermal Resistance $R\theta_{JP}$ (°C/W)
	Typ	Max	Min	Min	Typ
HSMC/A	1.9	2.4	5	-	280
HSMV/Z	2.2	2.6	5	-	280
HSMM/N	3.4	4.05	-	5	280

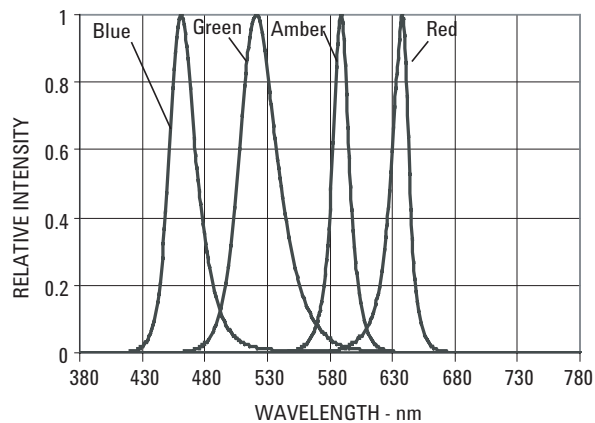


Figure 1. Relative Intensity vs. Wavelength

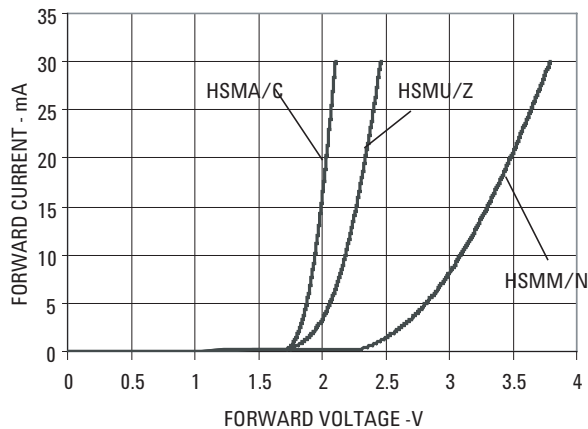


Figure 2. Forward Current vs. Forward Voltage

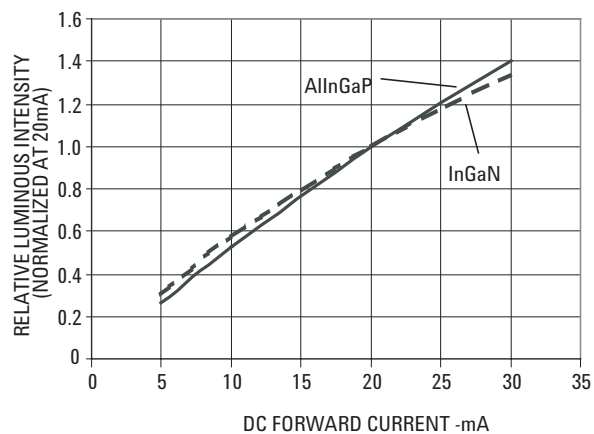


Figure 3. Relative Intensity vs. Forward Current

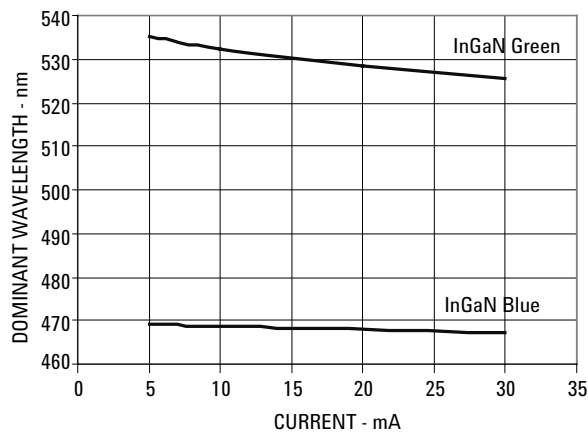


Figure 4. Dominant Wavelength vs. Forward Current – InGaP

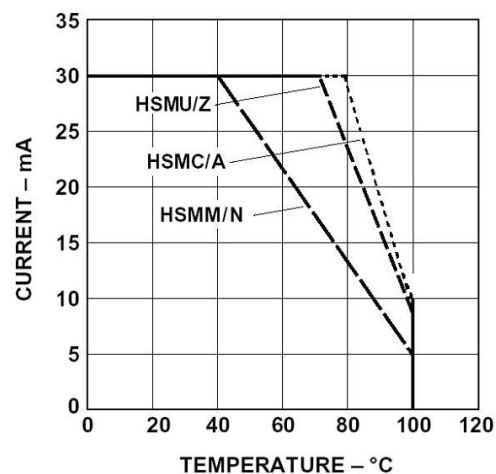


Figure 5. Maximum Forward Current Vs. Ambient Temperature.
Derated Based on $T_J \text{ MAX} = 110^\circ\text{C}$, $R\theta_{JA} 500^\circ\text{C/W}$

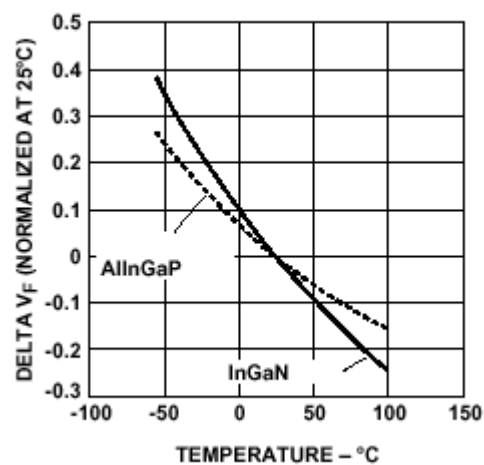


Figure 6. Forward Voltage Shift vs. Temperature

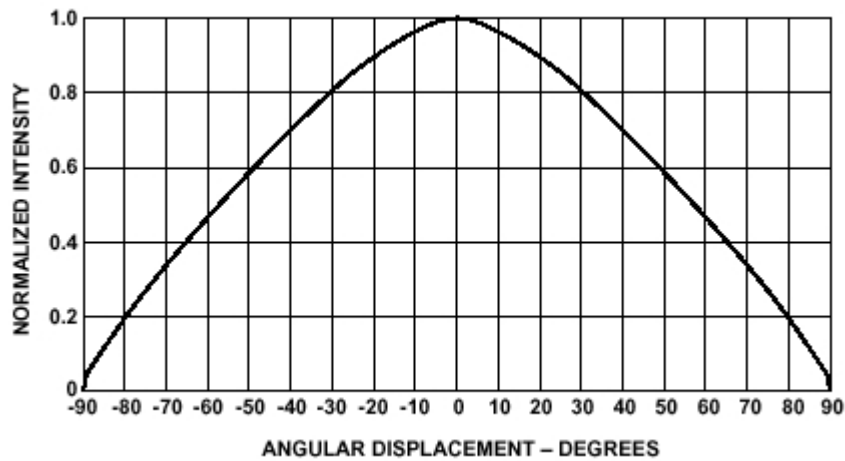


Figure 7. Radiation Pattern

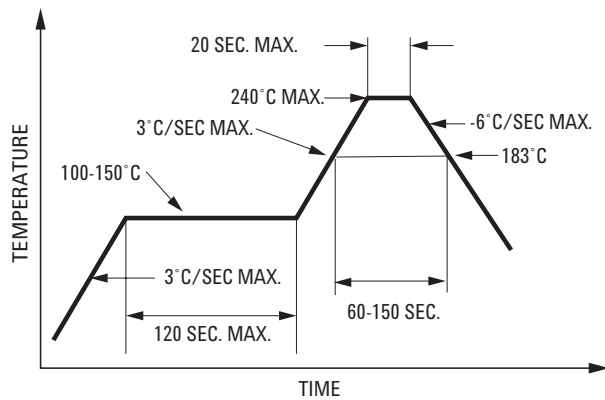


Figure 8a. Recommended SnPb Reflow Soldering Profile

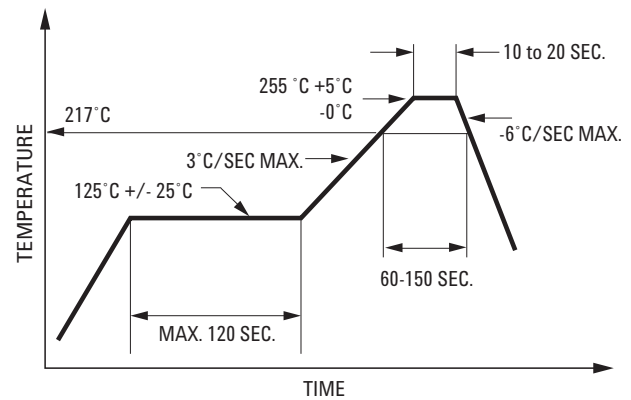


Figure 8b. Recommended Pb-Free Reflow Soldering Profile

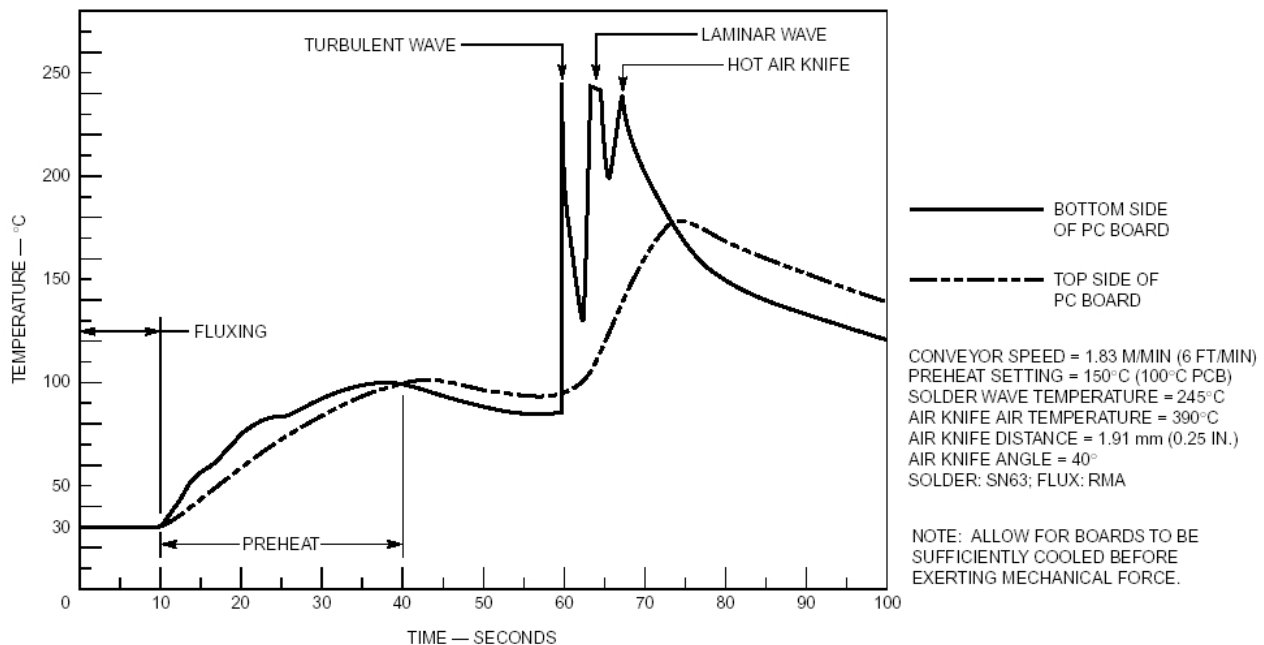
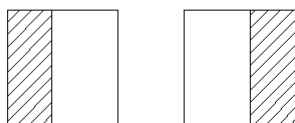
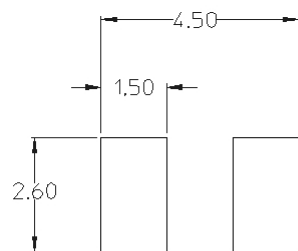


Figure 9. Recommended Wave Soldering Profile



▨ SOLDER RESIST

Figure 10. Recommended soldering pad pattern

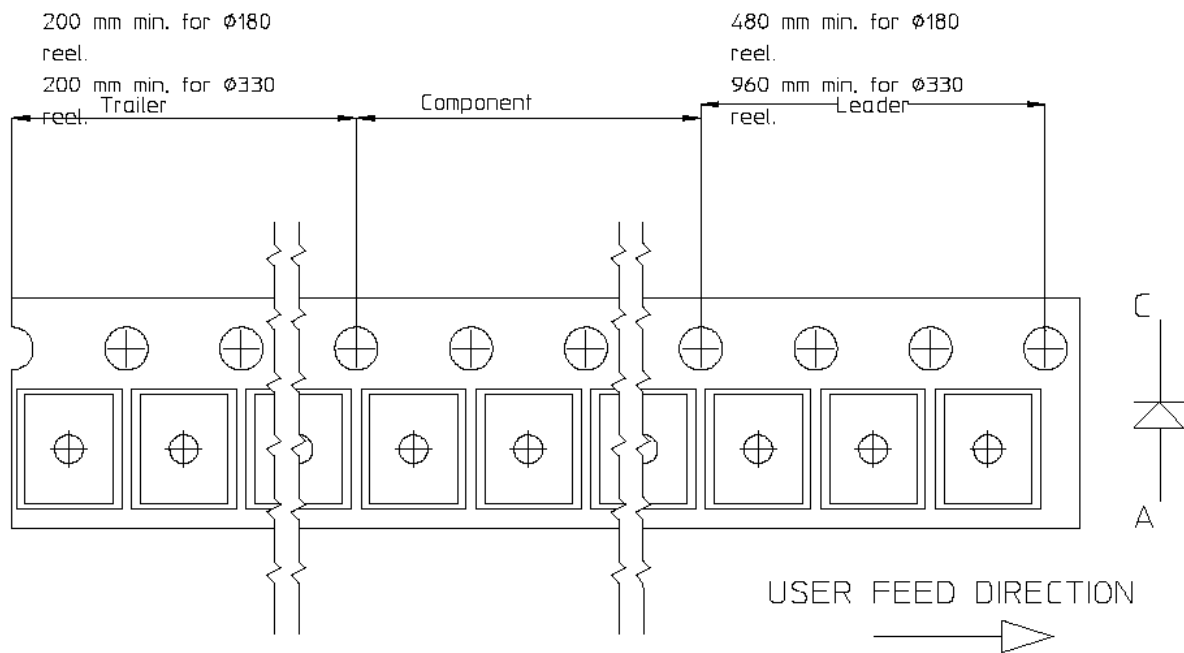


Figure 11. Tape leader and Trailer dimension

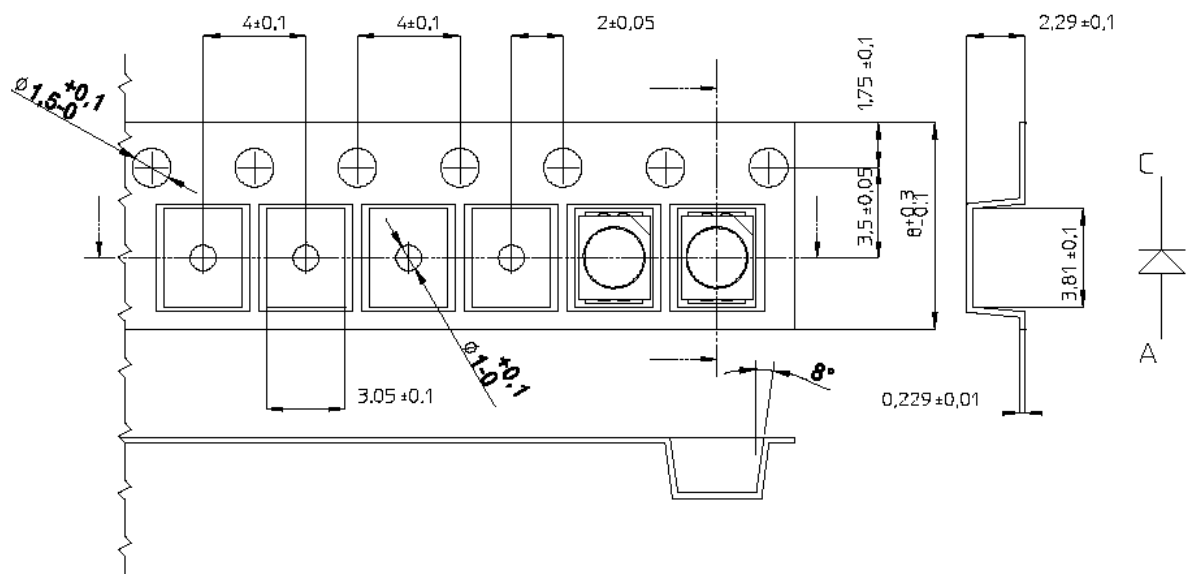


Figure 12. Tape dimension

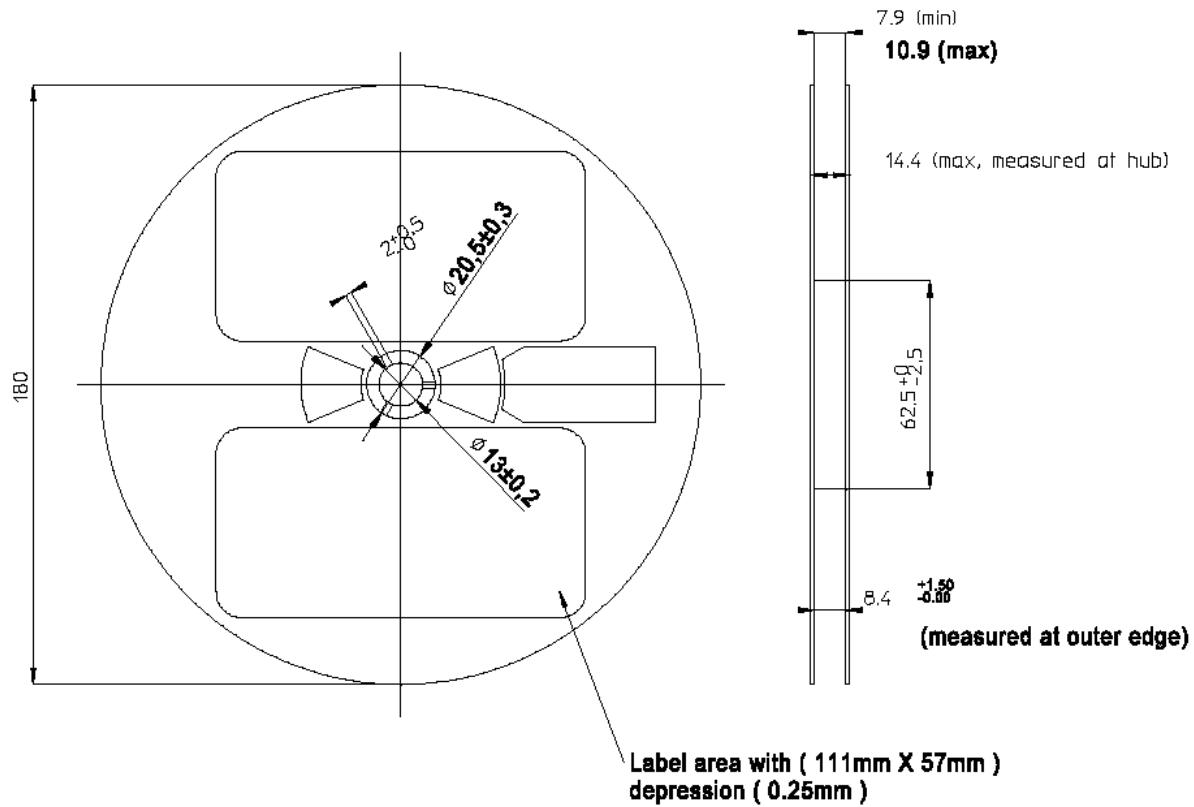


Figure 13. Reel dimension

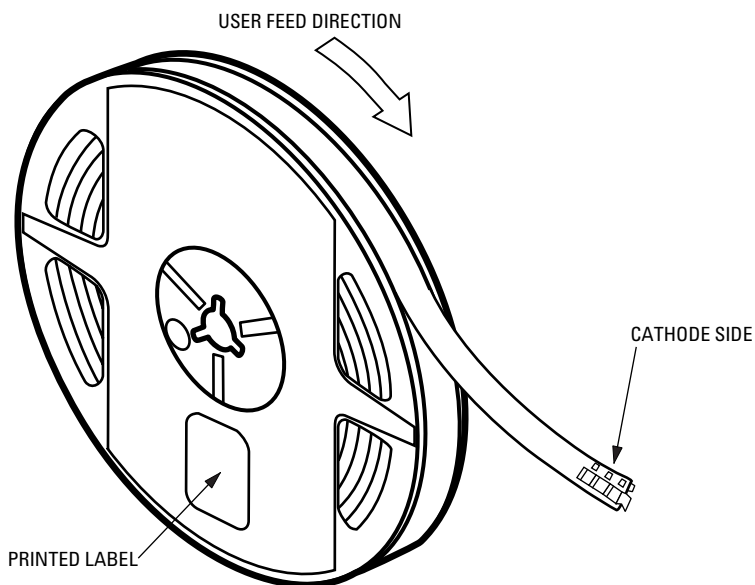


Figure 14. Reeling Orientation

Storage Conditions:

5 to 30° C @ 60% RH max.

Recommended baking conditions:

60 +/- 5°C for 20 hours.

Baking is required under the following conditions:

- the humidity indicator card becomes pink in color
- the pack has been opened for more than 4 weeks

This product is qualified as Moisture Sensitive JEDEC Level 2A

Intensity Bin Select (X₅X₆)

Individual reel will contain parts from 1 half bin only

X₅	Min Iv Bin
X₆	
0	Full Distribution
3	3 half bins starting from X ₅ 1
4	4 half bins starting from X ₅ 1
5	5 half bins starting from X ₅ 1
7	3 half bins starting from X ₅ 2
8	4 half bins starting from X ₅ 2
9	5 half bins starting from X ₅ 2

Intensity Bin Limits

Bin ID	Min (mcd)	Max (mcd)
J1	4.50	5.60
J2	5.60	7.20
K1	7.20	9.00
K2	9.00	11.20
L1	11.20	14.00
L2	14.00	18.00
M1	18.00	22.40
M2	22.40	28.50
N1	28.50	35.50
N2	35.50	45.00
P1	45.00	56.00
P2	56.00	71.50
Q1	71.50	90.00
Q2	90.00	112.50
R1	112.50	140.00
R2	140.00	180.00
S1	180.00	224.00
S2	224.00	285.00
T1	285.00	355.00
T2	355.00	450.00
U1	450.00	560.00
U2	560.00	715.00

Tolerance of each bin limit = $\pm 12\%$

Color Bin Select (X₇)

Individual reel will contain parts from 1 full bin only

X₇	
0	Full Distribution
Z	A and B only
Y	B and C only
W	C and D only
V	D and E only
U	E and F only
T	F and G only
S	G and H only
Q	A, B and C only
P	B, C and D only
N	C, D and E only
M	D, E and F only
L	E, F and G only
K	F, G and H only
1	A, B, C and D only
2	E, F G and H only

Color Bin Limits

Blue	Min (nm)	Max (nm)
A	460.0	465.0
B	465.0	470.0
C	470.0	475.0
D	475.0	480.0

Green	Min (nm)	Max (nm)
A	515.0	520.0
B	520.0	525.0
C	525.0	530.0
D	530.0	535.0

Amber/ Yellow	Min (nm)	Max (nm)
A	582.0	584.5
B	584.5	587.0
C	587.0	589.5
D	589.5	592.0
E	592.0	594.5
F	594.5	597.0

Red	Min (nm)	Max (nm)
Full Distribution		

Tolerance of each bin limit = $\pm 1\text{nm}$

Packaging Option (X₈X₉)

X₈X₉	
J1	20mA test current, Top Mount, 7 inch Reel
J2	10mA test current, Top Mount, 7 inch Reel

www.agilent.com/semiconductors

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